

NOT RECOMMENDED FOR NEW DESIGN USE DMN3030LSS



SINGLE N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
 - 18.5mΩ @ V_{GS} = 10V
 - 31mΩ @ V_{GS} = 4.5V
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 2)
- "Green" Device (Note 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.072g (approximate)





Maximum Ratings @T_A = 25°C unless otherwise specified

C	haracteristic		Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
Drain Current (Note 1)	Steady State	T _A = 25°C T _A = 70°C	lo	9 6.75	А
Pulsed Drain Current (Note 3)			IDM	40	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 1)	PD	2.5	W
Thermal Resistance, Junction to Ambient	R _{θJA}	50	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Notes: 1. Device mounted on 2 oz copper pad layout with $R_{0JA} = 50^{\circ}C/W$.

- 2. No purposefully added lead.
- 3. Pulse width $\leq 10\mu$ S, Duty Cycle $\leq 1\%$.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.



Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 5)						-
Gate Threshold Voltage	V _{GS(th)}	1	_	2.1	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	R _{DS (ON)}		15 26	18.5 31	mΩ	V _{GS} = 10V, I _D = 9A V _{GS} = 4.5V, I _D = 7A
Forward Transconductance	g _{fs}	_	5.8	_	S	$V_{DS} = 10V, I_{D} = 9A$
Diode Forward Voltage (Note 5)	V _{SD}	0.5	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 2.1A$
DYNAMIC CHARACTERISTICS						
Input Capacitance	Ciss	_	741	_	pF	
Output Capacitance	Coss	_	124	_	pF	V _{DS} = 15V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	95		pF	
Gate Resistance	R _G	0.30	0.88	1.5	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
SWITCHING CHARACTERISTICS						
Tatal Cata Charge	0	_	7.6	12	nC	$V_{DS} = 15V, V_{GS} = 4.5V, I_{D} = 9A$
Total Gate Charge	Qg	_	16.7	25		
Gate-Source Charge	Q _{gs}	_	1.9		nc	$V_{DS} = 15V, V_{GS} = 10V, I_D = 9A$
Gate-Drain Charge	Q _{gd}	_	5.2			
Turn-On Delay Time	t _{d(on)}	_	4.0			
Rise Time	tr		4.4	—		$V_{GS} = 10V, V_{DS} = 15V,$
Turn-Off Delay Time	t _{d(off)}	<u> </u>	23.0		ns	$R_L = 15\Omega, R_G = 6\Omega$
Fall Time	tf		9.4			

Notes: 5. Short duration pulse test used to minimize self-heating effect.





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DMN3031LSS





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Ordering Information (Note 6)

Part Number	Case	Packaging
DMN3031LSS-13	SO-8	2500/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information





Package Outline Dimensions





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